

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT4517847

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ASSAF LAHAV	07/23/2017
AMOS FENIGSTEIN	07/23/2017
YAKOV ROIZIN	07/23/2017
AVI STRUM	07/23/2017
RECEIVING PARTY DATA	
Name:	TOWER SEMICONDUCTOR LTD.
Street Address:	RAMAT GABRIEL INDUSTRIAL AREA
Internal Address:	P.O. BOX 619
City:	MIGDAL HAEMEK
State/Country:	ISRAEL
Postal Code:	23105
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15658328
CORRESPONDENCE DATA	
Fax Number:	(408)645-6548
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	925-895-3545
Email:	credick@beverlaw.com
Correspondent Name:	BEVER, HOFFMAN & HARMS, LLP
Address Line 1:	39500 STEVENSON PLACE
Address Line 2:	SUITE 209
Address Line 4:	FREMONT, CALIFORNIA 94539
ATTORNEY DOCKET NUMBER:	TSL-216-1P
NAME OF SUBMITTER:	PATRICK T. BEVER
SIGNATURE:	/Patrick T. Bever/
DATE SIGNED:	07/24/2017
Total Attachments: 1	

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, we

Assaf Lahav of Ramat Gabriel Industrial Area P.O. Box 619 Migdal Haemek Israel 23105
Amos Fenigstein of Ramat Gabriel Industrial Area P.O. Box 619 Migdal Haemek Israel 23105
Yakov Roizin of Ramat Gabriel Industrial Area P.O. Box 619 Migdal Haemek Israel 23105
Avi Strum of Ramat Gabriel Industrial Area P.O. Box 619 Migdal Haemek Israel 23105

hereby sell, assign and transfer to **Tower Semiconductor Ltd.**, an Israeli corporation, having a place of business at Ramat Gabriel Industrial Area P.O. Box 619 Migdal Haemek Israel 23105, its successors and assigns, the entire right, title and interest throughout the world in our invention in

**"Image Sensor Pixel With Memory Node Having Buried
Channel And Diode Portions Formed On N-Type Substrate"**

for which a United States patent application was filed, or will be filed on or about the date of the this Assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; we authorize the above-named joint assignees to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from us; we agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said joint assignees, their successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and we request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named joint assignees, its successors and assigns.

Executed this 23 day of July, 2017.

Assaf Lahav

Signature Witness 1: Yakov Roizin
(Print name)

Signature Witness 2: Yoav Hirsch
(Print name)

Executed this 23 day of July, 2017.

Amos Fenigstein

Signature Witness 1: Yakov Roizin
(Print name)

Signature Witness 2: Yoav Hirsch
(Print name)

Executed this 23 day of July, 2017.

Yakov Roizin

Signature Witness 1: Assaf Lahav
(Print name)

Signature Witness 2: Amos Fenigstein
(Print name)

Executed this 23 day of July, 2017.

Avi Strum

Signature Witness 1: Assaf Lahav
(Print name)

Signature Witness 2: Ellad Avshalomova
(Print name)

PATENT